

## DS90LV011A 3V LVDS Single High Speed Differential Driver

Check for Samples: [DS90LV011A](#)

### FEATURES

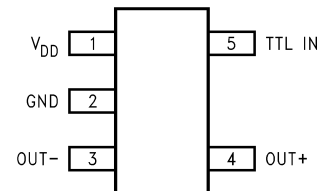
- Conforms to TIA/EIA-644-A Standard
- >400Mbps (200MHz) Switching Rates
- 700 ps (100 ps Typical) Maximum Differential Skew
- 1.5 ns Maximum Propagation Delay
- Single 3.3V Power Supply
- $\pm 350$  mV Differential Signaling
- Power Off Protection (Outputs in TRI-STATE)
- Pinout Simplifies PCB Layout
- Low Power Dissipation (23 mW @ 3.3V Typical)
- SOT-23 5-Lead Package
- SOT-23 Version Pin Compatible with SN65LVDS1
- Fabricated with Advanced CMOS Process Technology
- Industrial Temperature Operating Range
  - (–40°C to +85°C)

### DESCRIPTION

The DS90LV011A is a single LVDS driver device optimized for high data rate and low power applications. The DS90LV011A is a current mode driver allowing power dissipation to remain low even at high frequency. In addition, the short circuit fault current is also minimized. The device is designed to support data rates in excess of 400Mbps (200MHz) utilizing Low Voltage Differential Signaling (LVDS) technology.

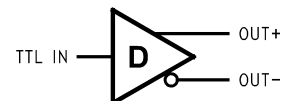
The device is in a 5-lead SOT-23 package. The LVDS outputs have been arranged for easy PCB layout. The differential driver outputs provide low EMI with its typical low output swing of 350 mV. The DS90LV011A can be paired with its companion single line receiver, the DS90LV012A, or with any of TI's LVDS receivers, to provide a high-speed LVDS interface.

### Connection Diagram



**Figure 1. Top View**  
See Package Number DBV (R-PDSO-G5)

### Functional Diagram



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



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**Absolute Maximum Ratings<sup>(1)</sup>**

|                                           |                        |
|-------------------------------------------|------------------------|
| Supply Voltage ( $V_{DD}$ )               | -0.3V to +4V           |
| LVC MOS input voltage (TTL IN)            | -0.3V to +3.6V         |
| LVDS output voltage ( $OUT_{\pm}$ )       | -0.3V to +3.9V         |
| LVDS output short circuit current         | 24mA                   |
| Maximum Package Power Dissipation @ +25°C |                        |
| DBV Package                               | 902 mW                 |
| Derate DBV Package                        | 7.22 mW/°C above +25°C |
| Thermal Resistance ( $\theta_{JA}$ )      | 138.5°C/Watt           |
| Storage Temperature                       | -65°C to +150°C        |
| Lead Temperature – Soldering              | +260°C (4 sec.)        |
| Maximum Junction Temperature              | +150°C                 |
| ESD Ratings                               |                        |
| HBM (1.5 k $\Omega$ , 100 pF)             | $\geq 9$ kV            |
| EIAJ (0 $\Omega$ , 200 pF)                | $\geq 900$ V           |
| CDM (0 $\Omega$ , 0 pF)                   | $\geq 2000$ V          |
| IEC direct (330 $\Omega$ , 150 pF)        | $\geq 4$ kV            |

- (1) "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be specified. They are not meant to imply that the devices should be operated at these limits. [Electrical Characteristics](#) specifies conditions of device operation.

**Recommended Operating Conditions**

|                             | Min | Typ | Max | Units |
|-----------------------------|-----|-----|-----|-------|
| Supply Voltage ( $V_{DD}$ ) | 3.0 | 3.3 | 3.6 | V     |
| Temperature ( $T_A$ )       | -40 | +25 | +85 | °C    |

## Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified. <sup>(1)(2)(3)</sup>

| Symbol           | Parameter                                                | Conditions                                           |                                          | Pin             | Min   | Typ  | Max             | Units |
|------------------|----------------------------------------------------------|------------------------------------------------------|------------------------------------------|-----------------|-------|------|-----------------|-------|
| V <sub>OD</sub>  | Output Differential Voltage                              | R <sub>L</sub> = 100Ω<br>(Figure 2 and Figure 3)     |                                          | OUT+,<br>OUT–   | 250   | 350  | 450             | mV    |
| ΔV <sub>OD</sub> | V <sub>OD</sub> Magnitude Change                         |                                                      |                                          |                 |       | 3    | 35              | mV    |
| V <sub>OS</sub>  | Offset Voltage                                           | R <sub>L</sub> = 100Ω<br>(Figure 2)                  |                                          |                 | 1.125 | 1.22 | 1.375           | V     |
| ΔV <sub>OS</sub> | Offset Magnitude Change                                  |                                                      |                                          |                 | 0     | 1    | 25              | mV    |
| I <sub>OFF</sub> | Power-off Leakage                                        | V <sub>OUT</sub> = 3.6V or GND, V <sub>DD</sub> = 0V |                                          |                 |       | ±1   | ±10             | μA    |
| I <sub>OS</sub>  | Output Short Circuit Current <sup>(4)</sup>              | V <sub>OUT+</sub> and V <sub>OUT-</sub> = 0V         |                                          |                 |       | –6   | –24             | mA    |
| I <sub>OSD</sub> | Differential Output Short Circuit Current <sup>(4)</sup> | V <sub>OD</sub> = 0V                                 |                                          |                 |       | –5   | –12             | mA    |
| C <sub>OUT</sub> | Output Capacitance                                       |                                                      |                                          |                 |       |      | 3               |       |
| V <sub>IH</sub>  | Input High Voltage                                       |                                                      |                                          | TTL IN          | 2.0   |      | V <sub>DD</sub> | V     |
| V <sub>IL</sub>  | Input Low Voltage                                        |                                                      |                                          |                 | GND   |      | 0.8             | V     |
| I <sub>IH</sub>  | Input High Current                                       | V <sub>IN</sub> = 3.3V or 2.4V                       |                                          |                 |       | ±2   | ±10             | μA    |
| I <sub>IL</sub>  | Input Low Current                                        | V <sub>IN</sub> = GND or 0.5V                        |                                          |                 |       | ±1   | ±10             | μA    |
| V <sub>CL</sub>  | Input Clamp Voltage                                      | I <sub>CL</sub> = –18 mA                             |                                          |                 | –1.5  | –0.6 |                 | V     |
| C <sub>IN</sub>  | Input Capacitance                                        |                                                      |                                          |                 |       | 3    |                 | pF    |
| I <sub>DD</sub>  | Power Supply Current                                     | No Load                                              | V <sub>IN</sub> = V <sub>DD</sub> or GND | V <sub>DD</sub> |       | 5    | 8               | mA    |
|                  |                                                          | R <sub>L</sub> = 100Ω                                |                                          |                 |       | 7    | 10              | mA    |

- (1) Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground except  $V_{OD}$ .
- (2) All typicals are given for:  $V_{DD} = +3.3V$  and  $T_A = +25^\circ C$ .
- (3) The DS90LV011A is a current mode device and only function with datasheet specification when a resistive load is applied to the drivers outputs.
- (4) Output short circuit current ( $I_{OS}$ ) is specified as magnitude only, minus sign indicates direction only.

## Switching Characteristics

Over Supply Voltage and Operating Temperature Ranges, unless otherwise specified. <sup>(1)(2)(3)(4)</sup>

| Symbol     | Parameter                                                      | Conditions                                                   | Min | Typ | Max | Units |
|------------|----------------------------------------------------------------|--------------------------------------------------------------|-----|-----|-----|-------|
| $t_{PHLD}$ | Differential Propagation Delay High to Low                     | $R_L = 100\Omega$ , $C_L = 15$ pF<br>(Figure 4 and Figure 5) | 0.3 | 1.0 | 1.5 | ns    |
| $t_{PLHD}$ | Differential Propagation Delay Low to High                     |                                                              | 0.3 | 1.1 | 1.5 | ns    |
| $t_{SKD1}$ | Differential Pulse Skew $ t_{PHLD} - t_{PLHD} $ <sup>(5)</sup> |                                                              | 0   | 0.1 | 0.7 | ns    |
| $t_{SKD3}$ | Differential Part to Part Skew <sup>(6)</sup>                  |                                                              | 0   | 0.2 | 1.0 | ns    |
| $t_{SKD4}$ | Differential Part to Part Skew <sup>(7)</sup>                  |                                                              | 0   | 0.4 | 1.2 | ns    |
| $t_{TLH}$  | Transition Low to High Time                                    |                                                              | 0.2 | 0.5 | 1.0 | ns    |
| $t_{THL}$  | Transition High to Low Time                                    |                                                              | 0.2 | 0.5 | 1.0 | ns    |
| $f_{MAX}$  | Maximum Operating Frequency <sup>(8)</sup>                     |                                                              | 200 | 250 |     | MHz   |

- (1) All typicals are given for:  $V_{DD} = +3.3V$  and  $T_A = +25^\circ C$ .
- (2) These parameters are specified by design. The limits are based on statistical analysis of the device performance over PVT (process, voltage, temperature) ranges.
- (3)  $C_L$  includes probe and fixture capacitance.
- (4) Generator waveform for all tests unless otherwise specified:  $f = 1$  MHz,  $Z_O = 50\Omega$ ,  $t_r \leq 1$  ns,  $t_f \leq 1$  ns (10%-90%).
- (5)  $t_{SKD1}$ ,  $|t_{PHLD} - t_{PLHD}|$ , is the magnitude difference in differential propagation delay time between the positive going edge and the negative going edge of the same channel.
- (6)  $t_{SKD3}$ , Differential Part to Part Skew, is defined as the difference between the minimum and maximum specified differential propagation delays. This specification applies to devices at the same  $V_{DD}$  and within  $5^\circ C$  of each other within the operating temperature range.
- (7)  $t_{SKD4}$ , part to part skew, is the differential channel to channel skew of any event between devices. This specification applies to devices over recommended operating temperature and voltage ranges, and across process distribution.  $t_{SKD4}$  is defined as  $|Max - Min|$  differential propagation delay.
- (8)  $f_{MAX}$  generator input conditions:  $t_r = t_f < 1$  ns (0% to 100%), 50% duty cycle, 0V to 3V. Output criteria: duty cycle = 45%/55%,  $V_{OD} > 250mV$ . The parameter is specified by design. The limit is based on the statistical analysis of the device over the PVT range by the transitions times ( $t_{TLH}$  and  $t_{THL}$ ).

## PARAMETER MEASUREMENT INFORMATION

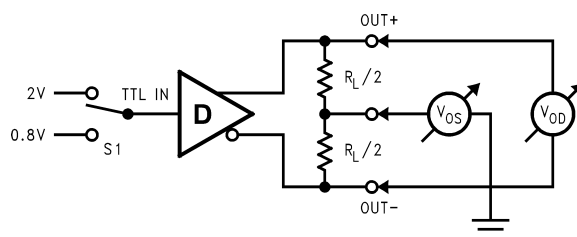


Figure 2. Differential Driver DC Test Circuit

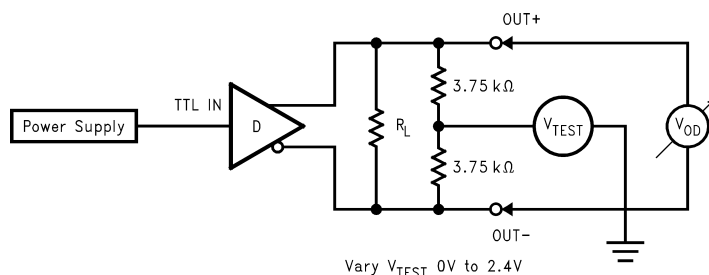


Figure 3. Differential Driver Full Load DC Test Circuit

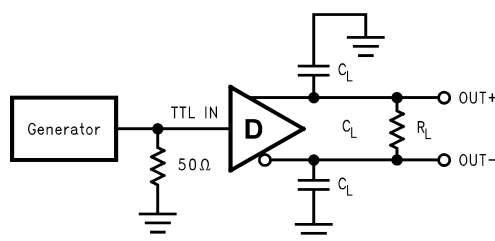


Figure 4. Differential Driver Propagation Delay and Transition Time Test Circuit

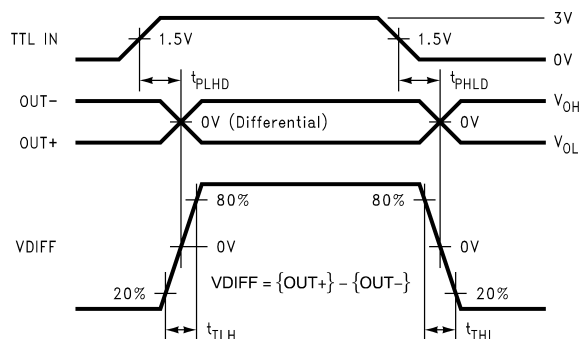


Figure 5. Differential Driver Propagation Delay and Transition Time Waveforms

## APPLICATION INFORMATION

**Table 1. Device Pin Descriptions**

| Package Pin Number | Pin Name        | Description                     |
|--------------------|-----------------|---------------------------------|
| SOT-23             |                 |                                 |
| 5                  | TTL IN          | LVTTL/LVCMOS driver input pins  |
| 4                  | OUT+            | Non-inverting driver output pin |
| 3                  | OUT–            | Inverting driver output pin     |
| 2                  | GND             | Ground pin                      |
| 1                  | V <sub>DD</sub> | Power supply pin, +3.3V ± 0.3V  |

REVISION HISTORY

| Changes from Revision B (April 2013) to Revision C         | Page              |
|------------------------------------------------------------|-------------------|
| • Changed layout of National Data Sheet to TI format ..... | <a href="#">5</a> |

## PACKAGING INFORMATION

| Orderable part number               | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">DS90LV011ATMF/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | N01                 |
| DS90LV011ATMF/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | N01                 |
| DS90LV011ATMFX/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | N01                 |
| <a href="#">DS90LV011ATMFX/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | N01                 |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device              | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| DS90LV011ATMF/NOPB  | SOT-23       | DBV             | 5    | 1000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| DS90LV011ATMF/NOPB  | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| DS90LV011ATMFX/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| DS90LV011ATMFX/NOPB | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device              | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| DS90LV011ATMF/NOPB  | SOT-23       | DBV             | 5    | 1000 | 210.0       | 185.0      | 35.0        |
| DS90LV011ATMF/NOPB  | SOT-23       | DBV             | 5    | 1000 | 210.0       | 185.0      | 35.0        |
| DS90LV011ATMFX/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| DS90LV011ATMFX/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |

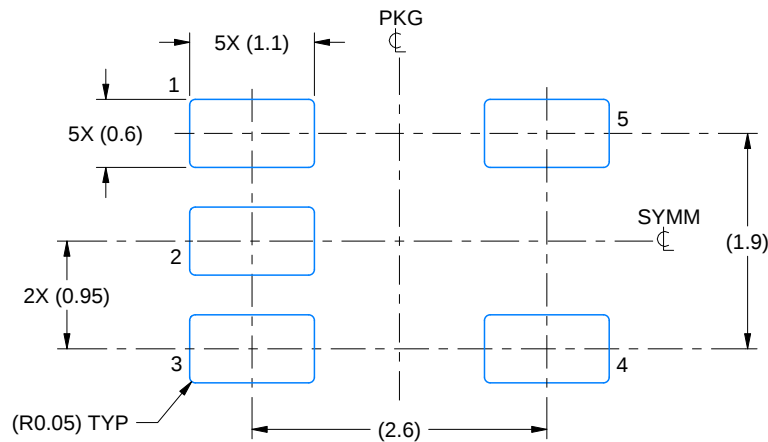


# EXAMPLE BOARD LAYOUT

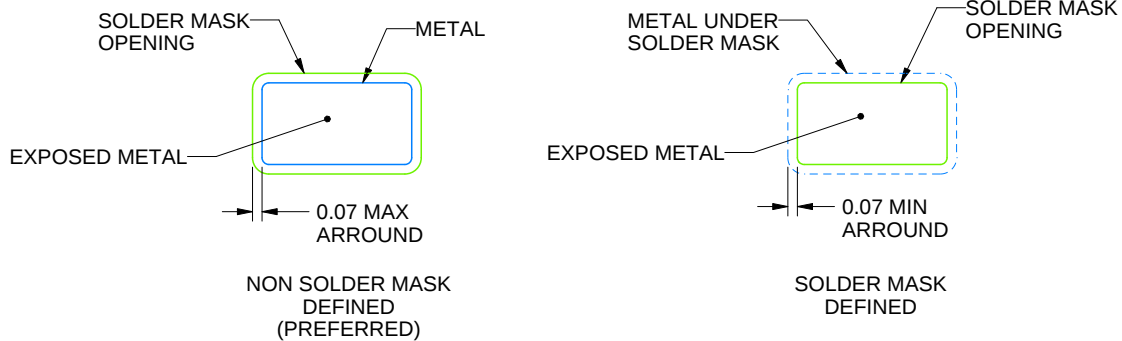
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

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NOTES: (continued)

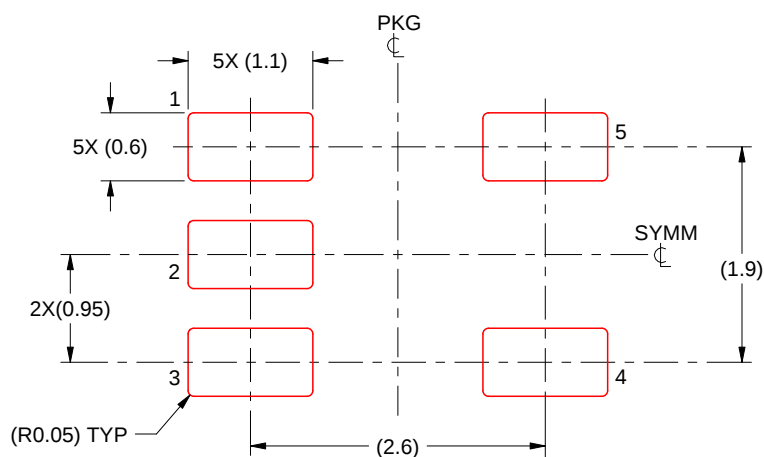
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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